

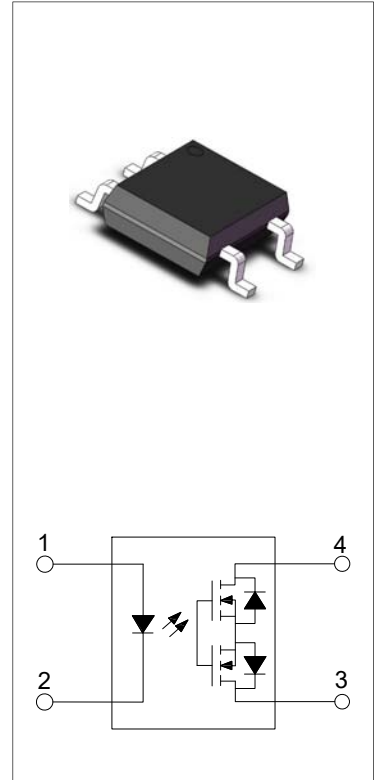


JOCMAXXC-M4 Series

Rev.A.1.0

DESCRIPTION:

The products are 4-pin optical relays. The device consists of an AlGaAs infrared emitting diode input stage optically coupled to a high-voltage output detector circuit in a plastic SOP4 package. The detector consists of a high-speed photovoltaic diode array and driver circuitry. The products are widely used in measuring and testing equipment, security and disaster prevention market, industrial machinery and equipment.



MAIN FEATURES

- High isolation 3750 Vrms
- Wide variation of load voltage 60V to 600V
- Operating temperature range -40°C to 110°C
- REACH & RoHS compliance
- HBM: H3A; MM: M4; CDM: C3
- CQC approved
- VDE approved
- UL approved

ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

Parameter		Symbol	Value	Unit
Input	Forward Current	I_F	50	mA
	Peak Forward Current	I_{FP}	1 ^①	A
	Reverse Voltage	V_R	6	V
	Input Power Dissipation	P_D	75	mW
Output	Load Voltage	JOCMA39C	60	V
		JOCMA38C	60	
		JOCMA57C	100	
		JOCMA66C	200	
		JOCMA75C	400	
		JOCMA74C	400	
		JOCMA83C	600	
	Continuous load current	JOCMA39C	2	A
		JOCMA38C	1	
		JOCMA57C	0.5	
		JOCMA66C	0.3	
		JOCMA75C	0.18	

	JOCMA74C	0.1	
	JOCMA83C	0.05	
	Output Power Dissipation	P _O	300 mW
Total Power Dissipation		P _{tot}	375 mW
Isolation Voltage		V _{iso}	3750 ^② V _{rms}
Operating Temperature		T _{opr}	-40~110 °C
Junction Temperature		T _j	125 °C
Storage Temperature		T _{stg}	-55~125 °C
Soldering Temperature		T _{sol}	260 °C

NOTE1 : 100μs pulse, 100Hz frequency

NOTE2 : AC for 1minute, R.H.=40~60%

ELECTRICAL CHARACTERISTICS (Temperature=25°C)

Parameter		Symbol	Condition	Min.	Typ.	Max.	Unit	
Input	Forward Voltage	V _F	I _F =10mA	-	1.2	1.5	V	
	Reverse Current	I _R	V _R =6V	-	-	1	μA	
	Action Current	I _{F(ON)}	I _L =I _{L(MAX)}	-	0.9	3	mA	
	Reset Current	I _{F(OFF)}	I _L =I _{L(MAX)}	0.4	0.8	-	mA	
Output	On Resistance	JOCMA39C	I _F =5mA I _L =Max. Within 1s on time	-	-	0.1	Ω	
		JOCMA38C		-	-	0.3		
		JOCMA57C		-	-	0.4		
		JOCMA66C		-	-	2.5		
		JOCMA75C		-	-	25		
		JOCMA74C		-	-	25		
		JOCMA83C		-	-	35		
	Off State Leakage Current	I _{Leak}	I _F =0mA, V _L =Max.	-	-	1	μA	
Output Capacitance	C _{OFF}	V _{OFF} =0V, f _o =1MHz	-	6	-	pF		
Switching Characteristics	Isolation Resistance	R _{iso}	DC500V 40~60%R.H.	10 ¹²	-	-	Ω	
	Floating Capacitance	C _{io}	V=0, f=1MHz	-	-	1.5	pF	
	Turn On Time	JOCMA39C	t _{on}	I _F =5mA, I _L =Max.	-	0.65	2	ms
		JOCMA38C			-	0.65	2	
		JOCMA57C			-	0.6	2	
		JOCMA66C			-	0.25	0.5	
		JOCMA75C			-	0.23	0.5	
		JOCMA74C			-	0.21	0.5	
JOCMA83C		-			0.18	0.5		

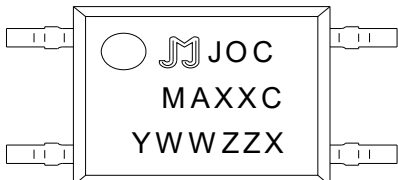
	Turn Off Time	JOCMA39C	t_{off}	$I_F=5mA,$ $I_L=Max.$	-	0.08	0.2	ms
		JOCMA38C			-	0.08	0.2	
		JOCMA57C			-	0.08	0.2	
		JOCMA66C			-	0.04	0.2	
		JOCMA75C			-	0.04	0.2	
		JOCMA74C			-	0.04	0.2	
		JOCMA83C			-	0.04	0.2	

ORDERING INFORMATION

J	OC	M	A	3	8	C	-M4	/
JieJie Microelectronics Co., Ltd.	Opto Coupler	MOS	A:1NO 3:V _O :60V 5:V _O :100V 6:V _O :200V 7:V _O :400V 8:V _O :600V			I _{FT} ≤ 3mA 9:I _O :2A 8:I _O :1A 7:I _O :0.5A 6:I _O :0.3A 5:I _O :0.18A 4:I _O :0.1A 3:I _O :0.05A	SOP4	None:T1 R:T2

Packing Quantity	
Option	Quantity
None/R	3000 Units/Reel

MARKING

	<p><u>YWWZZX</u></p> <p>———— LOT NO.</p>
---	--

Characteristics Curves

FIG.1: LED Dropout Voltage vs. Ambient Temperature

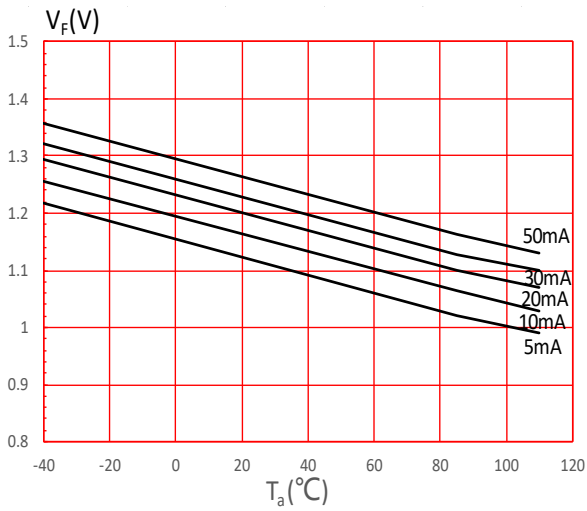


FIG.2: Output Current vs. Output Voltage

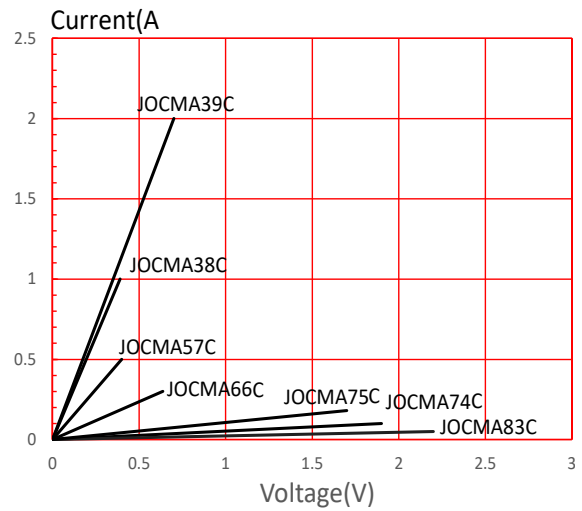


FIG.3: On Resistance vs. Ambient Temperature

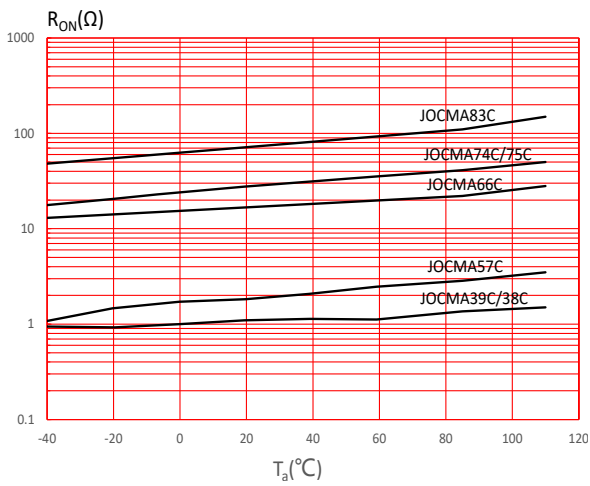


FIG.4: Load Current vs. Ambient Temperature

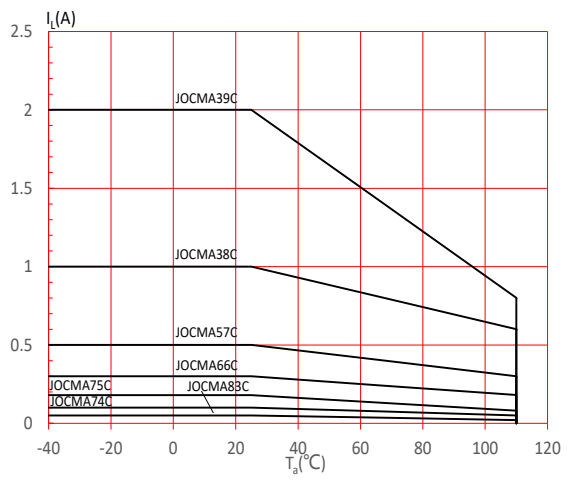


FIG.5: LED Operate Current vs. Ambient Temperature

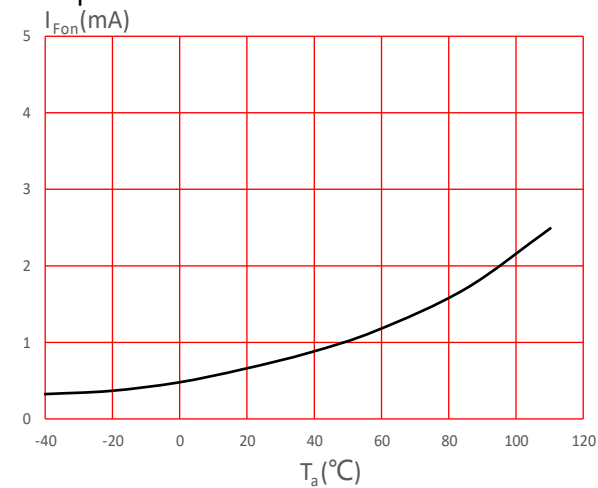


FIG.6: LED Turn Off Current vs. Ambient Temperature

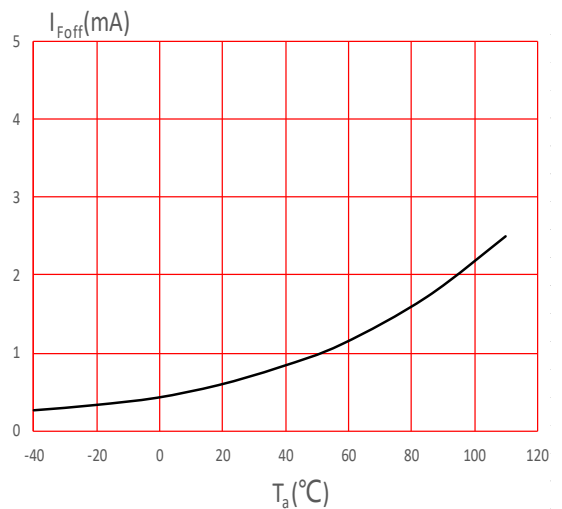


FIG.7: Turn On Time vs. Ambient Temperature

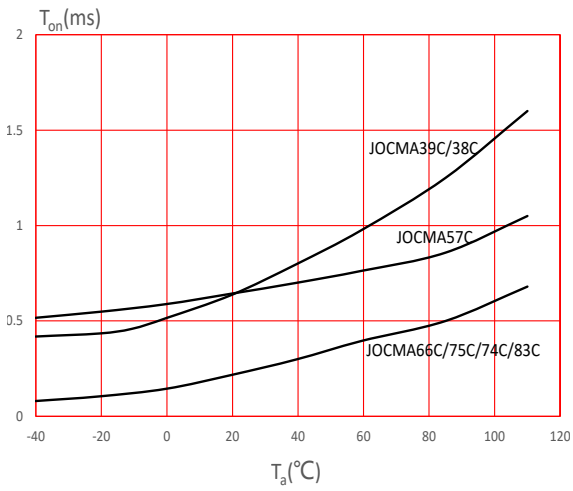


FIG.8: Turn Off Time vs. Ambient Temperature

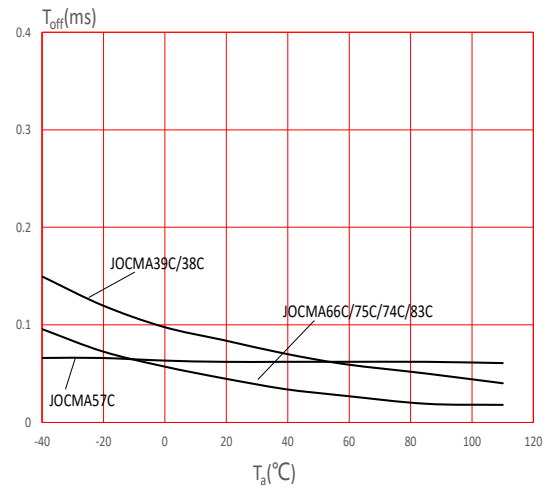


FIG.9: Turn On Time vs. LED Forward Current

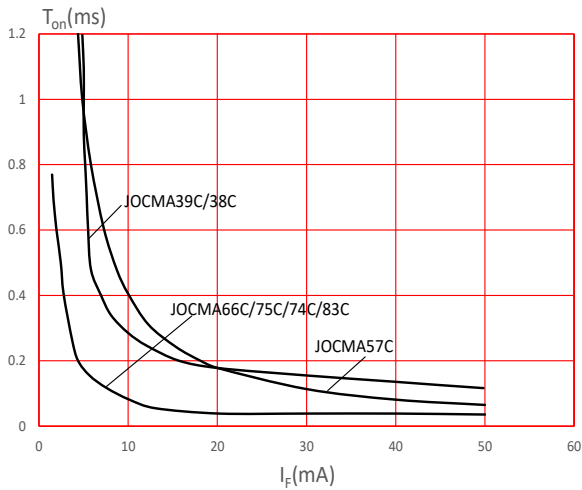


FIG.10: Turn Off Time vs. LED Forward Current

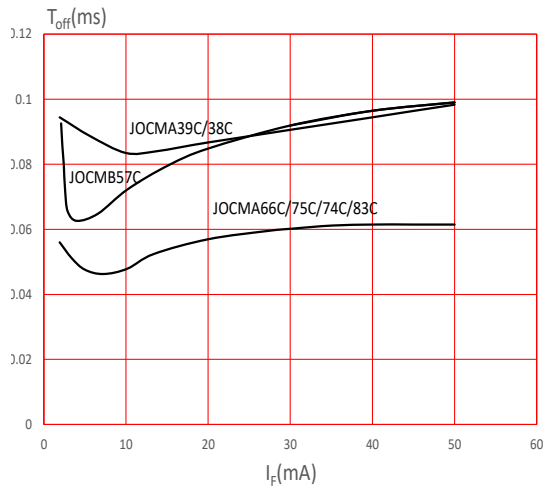


FIG.11: Off State Leakage Current vs. Load Voltage

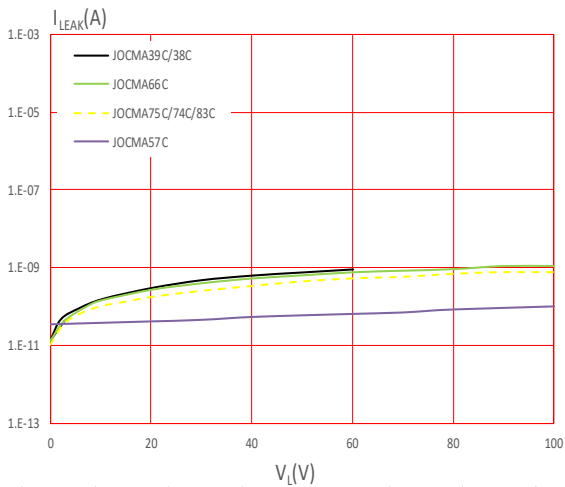
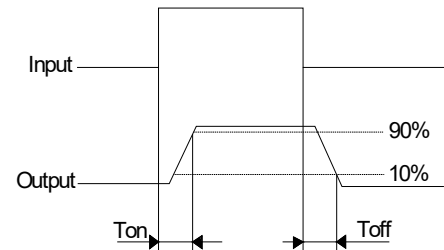
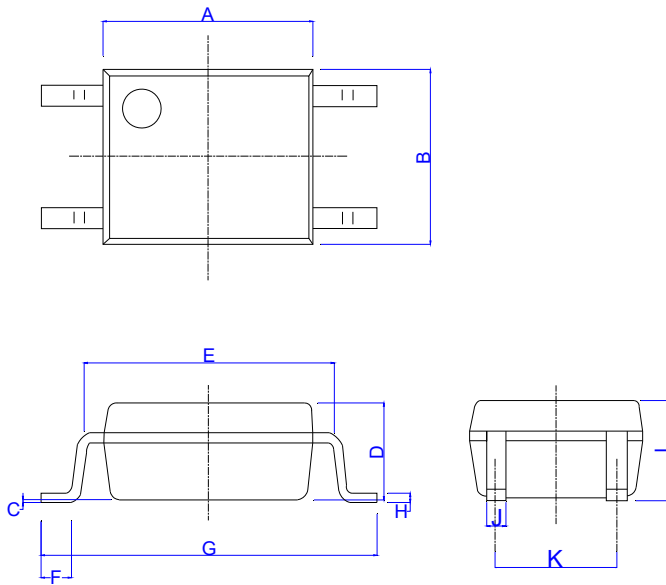


Fig.12: Turn on/Turn off time

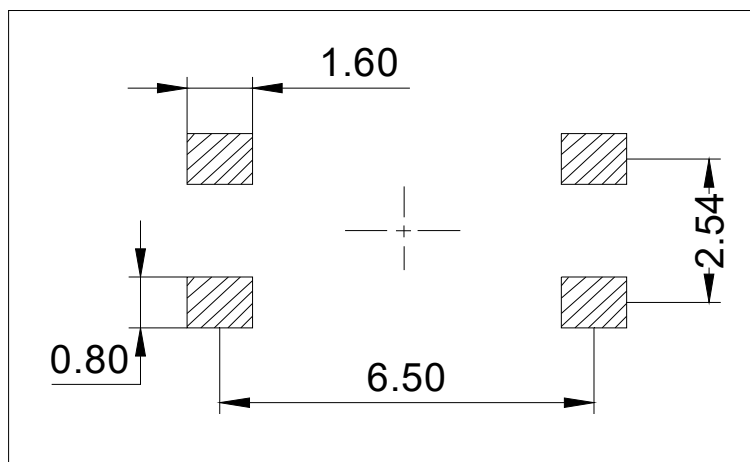


Package Dimension (Unit: mm)



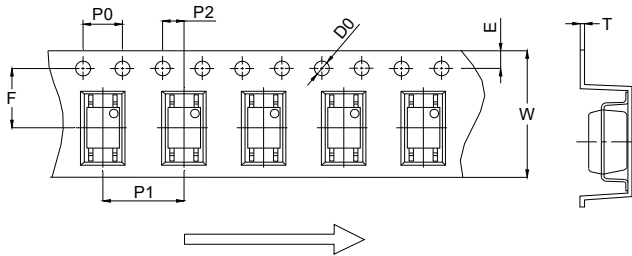
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.80	0.173		0.189
B	3.60		4.20	0.142		0.165
C	0.00		0.20	0.000		0.008
D	1.90		2.30	0.075		0.091
E	5.00		5.60	0.197		0.220
F	0.34		0.94	0.013		0.037
G	6.70		7.30	0.264		0.287
H	0.10		0.30	0.004		0.012
I	2.00		2.40	0.079		0.094
J	0.25		0.55	0.010		0.022
K	2.29		2.79	0.090		0.110

RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)



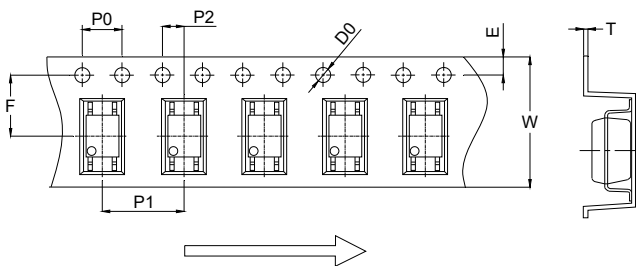
CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option None



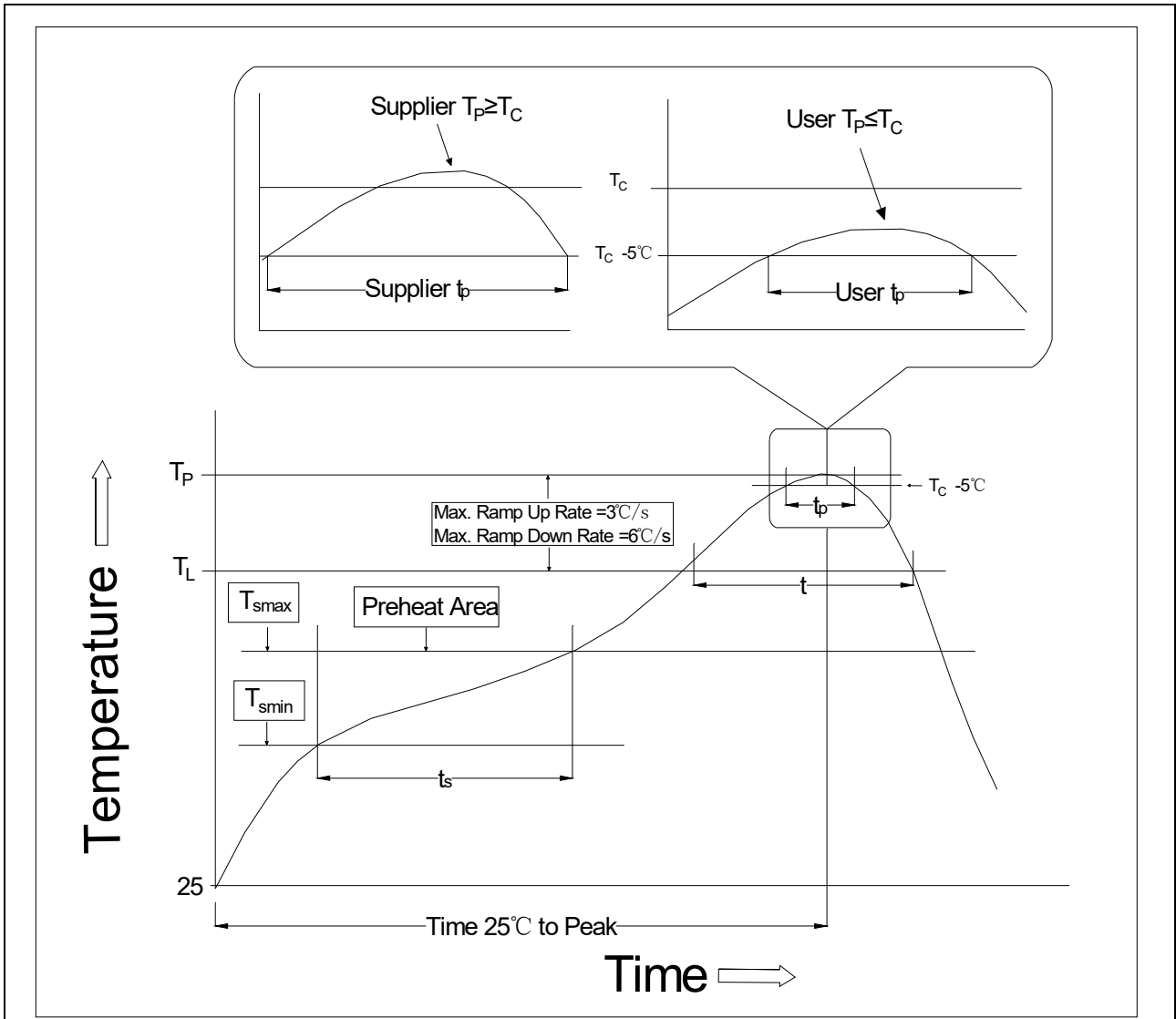
Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
D0		1.50	1.60		0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
E	1.65	1.75	1.85	0.065	0.069	0.073
F	4.40	4.50	4.60	0.173	0.177	0.181
T	0.25	0.30	0.35	0.010	0.012	0.014
W	11.90	12.00	12.30	0.469	0.472	0.484

Option R



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
D0		1.50	1.60		0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
E	1.65	1.75	1.85	0.065	0.069	0.073
F	4.40	4.50	4.60	0.173	0.177	0.181
T	0.25	0.30	0.35	0.010	0.012	0.014
W	11.90	12.00	12.30	0.469	0.472	0.484

REFLOW INFORMATION




Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (T _{smin})	100	150°C
Temperature Max. (T _{smax})	150	200°C
Time (t _s) from (T _{smin} to T _{smax})	60-120 seconds	60-120 seconds
Ramp-up Rate (t _L to t _P)	3°C/second max.	3°C/second max.
Liquidus Temperature (T _L)	183°C	217°C
Time (t _L) Maintained Above (T _L)	60-150 seconds	60-150 seconds
Peak Body Package Temperature	235°C+0°C/-5°C	260°C+0°C/-5°C
Time (t _P) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max.	6°C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.
3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.
4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.
5. The component has a shelf life of one year when stored under standard conditions.
6. Recommend storage Temp.: 0~40°C;
Recommend storage humidity: <60%;
MSL level: MSL 1

Information furnished in this document is believed to be accurate and reliable. However, Jiangsu JieJie Microelectronics Co., Ltd. assumes no responsibility for the consequences of use without consideration for such information nor use beyond it. Information mentioned in this document is subject to change without notice, apart from that when an agreement is signed, Jiangsu JieJie complies with the agreement.

Products and information provided in this document have no infringement of patents. Jiangsu JieJie assumes no responsibility for any infringement of other rights of third parties which may result from the use of such products and information. This document supersedes and replaces all information previously supplied.

 is a registered trademark of Jiangsu JieJie Microelectronics Co., Ltd.

Copyright © 2026 Jiangsu JieJie Microelectronics Co., Ltd. All rights reserved.